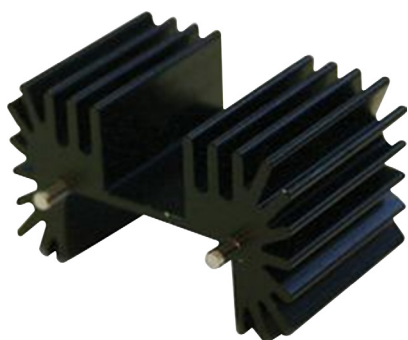




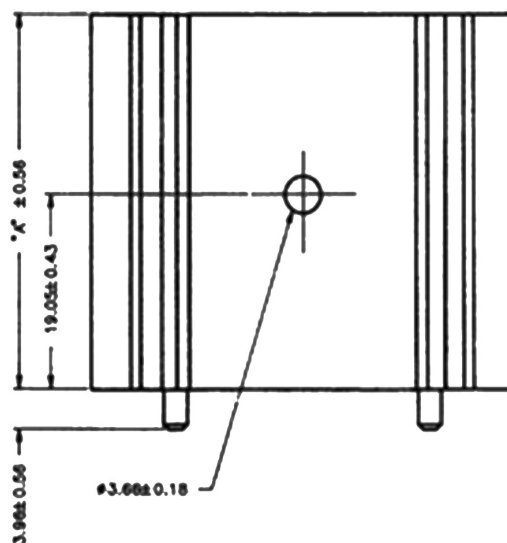
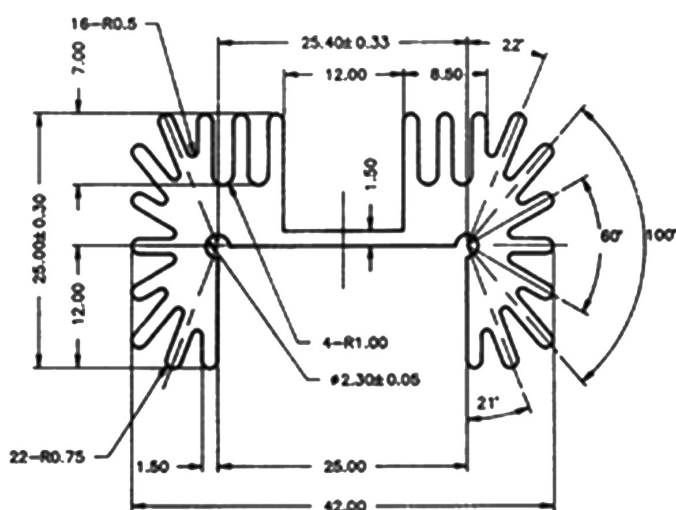
Description:

High power dissipation, vertical mounting extruded heatsink with solderable fixing pins and notched base. Pre-drilled for a single TO-218 / TO-220 / TO-247 package or via clip available separately.

Features:

- Choice of thermal resistance
- Low thermal resistance
- Solderable mounting pins
- Pre-drilled mounting holes
- Black anodize finish

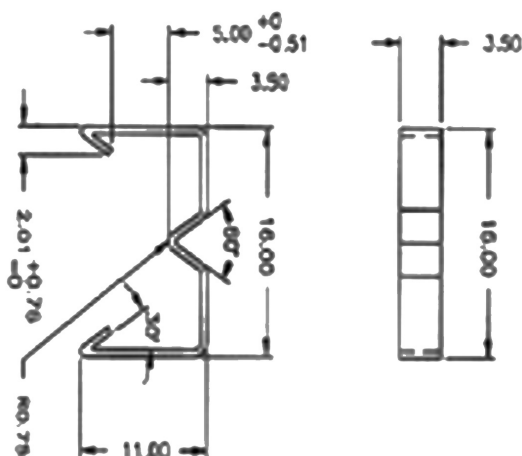
Diagram



Part Number	Thermal Resistance	Height	Width	Length
MC33269	4.4°C/W	38.1	42	25
MC33270	3.3°C/W	50.8		
MC33271	2.7°C/W	63.5		

Dimensions : Millimetres

Clip



Dimensions : Millimetres

Part Number Table

Description	Part Number
Heatsink TO-218 / TO-220 / TO-247 4.4°C/W	MC33269
Heatsink TO-218 / TO-220 / TO-247 3.3°C/W	MC33270
Heatsink TO-218 / TO-220 / TO-247 2.7°C/W	MC33271
Clip 003	MC33295

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